# Graduate Diploma in Integrated Circuits (IC) and Systems Design (Offline/Online Optional)

Organized by:

Department of Electrical Engineering,

**FAST NUCES ISLAMABAD** 

**Duration: 2 Semesters (09 Month),** 

1st Sept 2020 - 30th June 2021







# WHY INTEGRATED CIRCUITS (ICs) DESIGN ?

- IC Design is pivotal in 21<sup>st</sup> century technology trends; e.g. 5G systems, Artificial Intelligence (AI), and smart systems, which are supposed to be leading towards 5<sup>th</sup> industrial revolution
- Can be an excellent addition in resume for higher studies or job search abroad

  Lack of skilled IC designers in Pakistan is a major

Resulting a high demand of IC design engineers globally

A pool of skilled IC designers can attract international companies in Pakistan

bottleneck in international investments in circuit design

# WHY FROM FAST NUCES?

- A unique diploma program first time in Pakistan.
- Unique place in Pakistan to have IC design experience on Licensed Cadence Tool Suite
- Offers <u>hands-on</u> experience of IC design on TSMC officially provided 65nm, 130nm, and 150nm process development kits (PDKs)
- Each student will design and Fabrication the IC in TSMC 65nm CMOS node.
- A platform to learn modern IC design technique from Academics and Industrial Experts

## **ELIGIBILITY**

- Bachelor of:
- Electrical/Electronics Engineering
- Telecommunication Engineering
- Pre-requisite:
- Basic undergrad electronics courses
  - Excellent PA in Electronics Courses
    - Passion for the Electronics design.

# WHO SHOULD ENROLL

- Electrical Engineers looking for:IC design skills
  - PCB design skills
- Higher education aspirant from international universities
- Engineer aiming for stepping in semiconductor industry

## PROGRAM OUTCOME

- Will create a poll of skilled IC design
- engineers
   Pave the way for domestic IC design startups
- Help to eliminate the major issue of skilled technical workforce to attract international companies

#### PROGRAM OBJECTIVES

- Introduction to CMOS integrated circuits basics and fabrication process
- Detailed illustration and hands on experience of complete integrated circuit system design



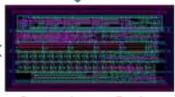
IC Schematic Design



Layout vs Schematic check



Design Rule Check

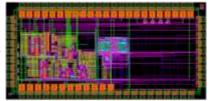


Simulation and Analysis

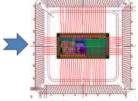
**Custom Layout Design** 



Verilog Digital Design Synthesis



Top Level IC Compilation



IC Packaging



Fabricated IC Testing



**PCB** Assembling



Printed Circuit Bard (PCB) Design

# TEACHING AND TECHNICAL STAFF

#### Prof. Dr. Rashad Ramzan

M.S. Royal Institute of Technology Stockholm, Sweden

Ph.D. Linkoping University, Sweden.

Professor Dept. of Electrical Engineering (EE), FAST, NUCES, ISB.

#### Dr. Hassan Saif

M.S. & Ph.D. Sungkyunkwan University, South Korea.

Asst. Prof., Dept. of EE FAST, NUCES, ISB.

#### **Engr. Muhammad Omar**

Sr. Design Engr. (High Frequency Sensors), Dept. of EE FAST, NUCES, ISB.

#### **Engr. Abdul Jabbar**

RF Design Engr. (RF Elect. & Frontend), Dept. of EE FAST, NUCES, ISB.

#### **Engr. Abdul Wajid**

Lab Engr. (IC Design),

Dept. of EE FAST, NUCES, ISB.

#### **Engr. Hamza Atiq**

Lab Engr. (RF & IC Design),

Dept. of EE FAST, NUCES, ISB.

## **COURSE OUTLINE**

# PRE-SEMESTER

# **SEMESTER 1**

#### 2 Week Crash Course **Course Contents** CMOS device characteristics. Combinational logic design, Sequential logic design, Verilog digital logic Synthesis and CAD

**Tools** 

# **Mixed Signal IC Design**

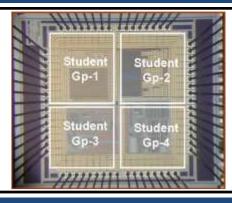
Non-linearity & Mismatch, IC fabrication process, Layout fundamentals, Sample and hold circuits, Performance metrics Digital to analog converters, Analog to Digital Converters, Z - Transform, Reference generators, Phase Lock Loop

# **Signal Integrity & SoC Design**

Signal integrity principals, Chip interconnect, Transmission lines and power planes, Clock distribution network, Pad types, Pad driver circuits, High speed characteristic, IBIS modeling IC Packaging types

# **SEMESTER 2 (IC DESIGN PROJECT)**

- IC design Group Project
- Schematic design to IC Tapeout for each student
- IC post-fabrication processing and packaging design
- IC testing tool & instruments training
- Fabricated IC testing and analysis
- **Technical paper writing**



# **REGISTRATION FEE AND DETAILS**

- Total Seats = 16 (8 Fellows + 8 Self Sponsored); Fee= 100K Pak Rs.
- When filling the form you can apply for fellowship.
- <u>Tution Fee</u> = PKR 100,000/- (inclusive of IC fabrication & testing facilities)
- Registration: Send the email to hassan.saif@nu.edu.pk, and CC to abdul.wajjid@nu.edu.pk
- Send Self written ½ page Application (Why you want to apply?), CV (include the GPA in Electronics Courses), Detail Marks Sheets
- Further Info: http://isb.nu.edu.pk/rfcs2/MS.htm

# **FELLOW SPONSORS**

- Dr. Khurram Muhammad (2 fellows)
- Dr. Bilal Zafar (2 fellows)
- Dr. Azam Beg (2 fellows)
- Dr. Rana Azhar (1 fellow)
  - Dr. Imtinan Elahi (1 fellow)